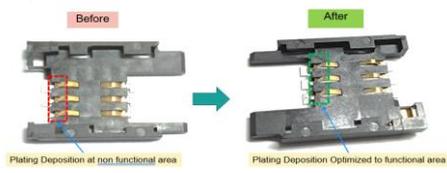


Product Name:	HPL – 584	
	Smartcard	
Product Manager:	Jimmy Wang	
Subject:	Notification of Change with Immediate Effectivity	
Distribution:	Affected customers	
Type of Change:	Process Change	
Change Description:	<p>Plating area optimization</p> <p>Plating deposition optimized to functional area</p>  <p>Plating Deposition at non functional area</p> <p>Plating Deposition Optimized to functional area</p>	
Reason for Change:	As part of continuous improvement plating deposition has be optimized to functional area.	
Affected Parts:	7111S1615A01LF;7111S1615A02LF	
Effective Date of Change:	February,10 2023	
Last Time Buy Date:		
Earliest Disty Return Date:		
Last Time Shipment Date		
Datasheet Attached?	Yes	
Qual/Test Data Attached?	Yes	
Samples Availability Date:	01 February ,2023	
Available Alternatives?		
Questions?	<p>Contact your local ACS Representative, or Product Manager</p> <p>Jimmy Wang / Product Manager</p> <p>jimmy.wang@fci.com</p>	

Note:

Customers should contact Product Line Manager (or their local Amphenol Representative) directly regarding any concern on the PCN. Lack of any such customer feedback within three weeks of PCN release date will be interpreted as non-objection .